

QT-Brightek Optocoupler Series

ZERO-CROSSING High Power TRIAC OPTOCOUPLER

Part No.: QTTX213 series

Product: QTTX213 series	Date: March 27, 2023	Page 1 of 15
	Version# 1.1	



Table of Contents:

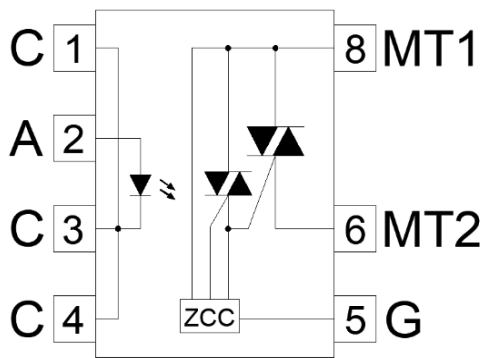
Introduction3
Absolute Maximum Rating6
Electrical Characteristic ($T_A=25\text{ }^\circ\text{C}$).....7
Characteristic Curves.....8
Packing & Labeling13
Ordering Information14
Revision History15
Disclaimer15

Introduction

Feature:

- High Isolation voltage between input and output (Viso = 5000 Vrms)
- Peak Breakdown Voltage: 600V
- Peak Current Load: 0.3A, 0.6A, 0.9A and 1.2A
- External creepage distance $\geq 7.0\text{mm}$
- Distance through isolation $\geq 0.4\text{mm}$
- External creepage $\geq 8\text{mm}$

Schematic:



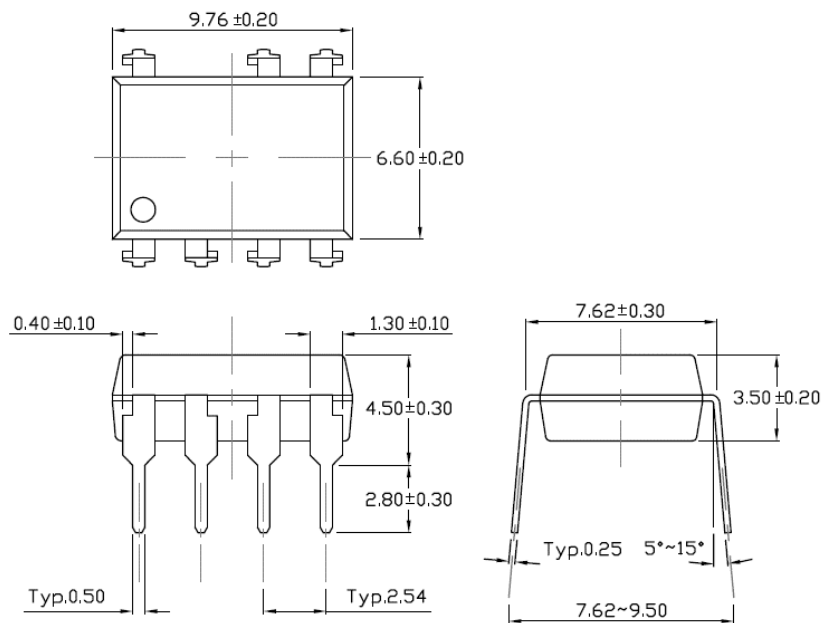
Certification & Compliance:

- Pb free and RoHS Compliant
- UL recognized (File #E338132)
- VDE (File #40049050)

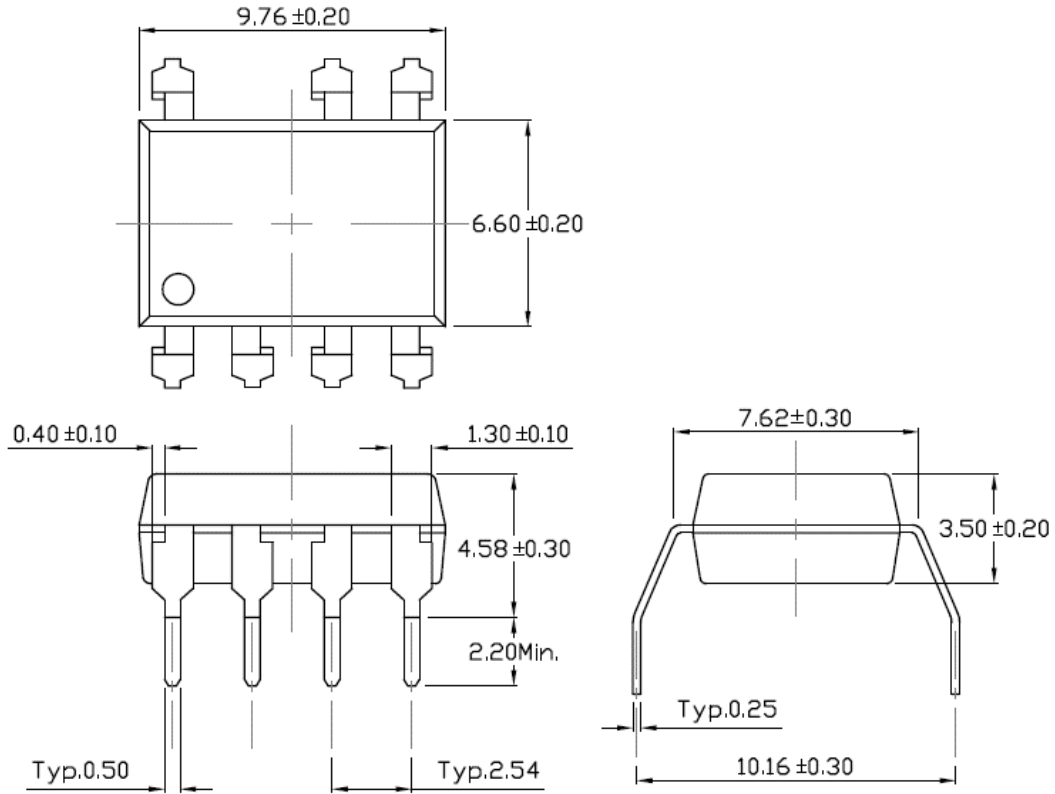


Dimension: (Dot location indicates pin 1)

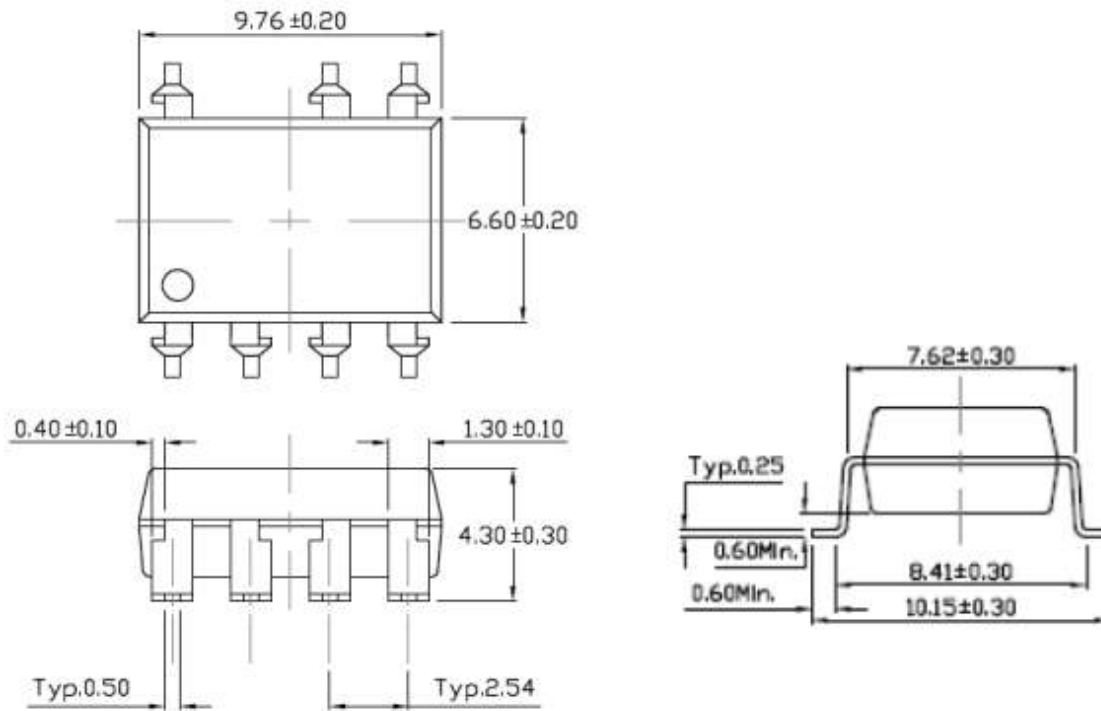
7-Pin Dip (standard):

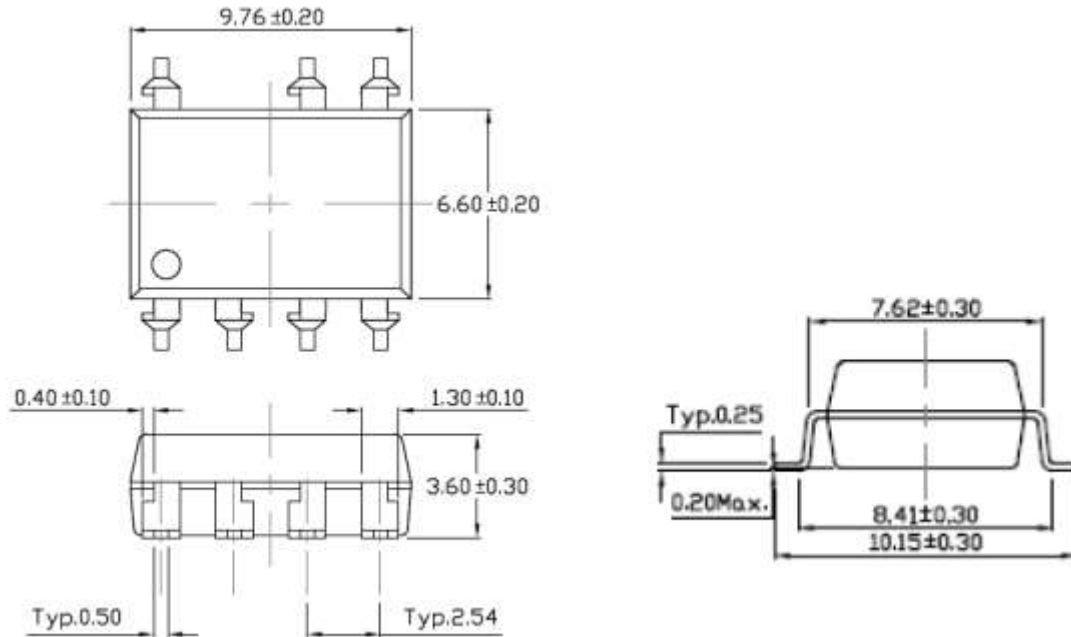


Gullwing (400mil) lead bend (Option M):



SMD lead bend (Option S):



SMD (Low Profile) bend (Option SL):

All Dimensions are in mm

Absolute Maximum Rating

Symbol	Parameter	Rating	Units	
V_{ISO}	Isolation Voltage*	5000	V_{RMS}	
T_{STG}	Storage Temperature	-40 ~ +85	$^{\circ}C$	
T_{OPR}	Operating Temperature	-40 ~ +125	$^{\circ}C$	
T_{SOL}	Soldering Temperature	260 for 10 sec	$^{\circ}C$	
EMITTER				
I_F	Continuous Forward Current	50	mA	
I_{FP}	Peak Forward Current ($\leq 1\mu s$, 300pps)	1	A	
V_R	Reverse Voltage	6	V	
P_D	Power Dissipation	75	mW	
DETECTOR				
P_{OUT}	Power Dissipation	800	mW	
P_T	Total Power Dissipation	850	mW	
$I_{T(RMS)}$	Continuous Current Load	QTT0213	0.3	A
		QTT1213	0.6	
		QTT2213	0.9	
		QTT3213	1.2	
I_{TSM}	Peak Current Load	QTT0213	3	A
		QTT1213	6	
		QTT2213	9	
		QTT3213	12	
V_{DRM}	Off-state Output Terminal Voltage	600	V	
I_{TSM}	Peak Repetitive Surge Current	1	A	

Electrical Characteristic (T_A=25 °C)
Emitter

Symbol	Characteristic	Test Condition	Range			Unit
			Min	Typ	Max	
V _F	Forward Voltage	I _F =10mA	-	-	1.4	V
I _R	Reverse Current	V _R =6V	-	-	5	μA
C _{IN}	Input Capacitance	f=1kHz	-	45	-	pF

Detector

Symbol	Characteristic	Test Condition	Range			Unit
			Min	Typ	Max	
I _{DRM1}	Peak Blocking Current	V _{DRM} =600V, I _F =0mA	-	-	100	μA
I _{DRM2}	Inhibit Leakage Current	I _F = Rated I _{FT} , V _{DRM} = 600V	-	-	500	μA
V _{INH}	Inhibit Voltage	I _F = Rated I _{FT} , V _{DRM} = 600V	-	-	50	V
V _{TM}	Peak on-state voltage	I _{TM} = 100mA peak, I _F = Rated I _{FT}	-	-	2.5	V
dv/dt	Critical Rate of Rise off-state voltage	V _{PEAK} = Rated V _{DRM}	200	-	-	V/μs

Transfer Characteristic

Symbol	Characteristic	Test Condition	Range			Unit
			Min	Typ	Max	
I _{FT}	LED Trigger Current	Main terminal voltage = 3V	-	-	10	mA
I _H	Holding Current	Terminal Voltage from "ON" to "OFF" "ON" state I _F =0mA	-	-	25	mA
T _{on}	Turn On Time	I _F = 20mA, V _D = 6V, R _L =100Ω		10	100	μs
R _{IO}	Isolation Resistance	V _{IO} =500V _{DC}	1x10 ¹¹	-	-	Ω
C _{IO}	Isolation Capacitance	f=1MHz	-	0.25	-	pF

Characteristic Curves

QTTX213

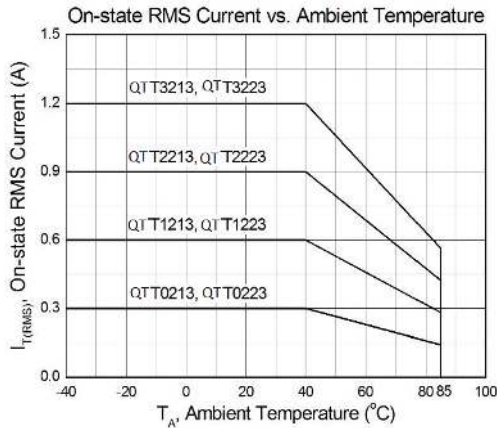


Figure 1

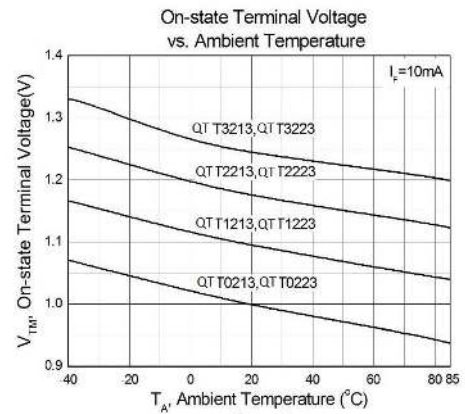


Figure 2

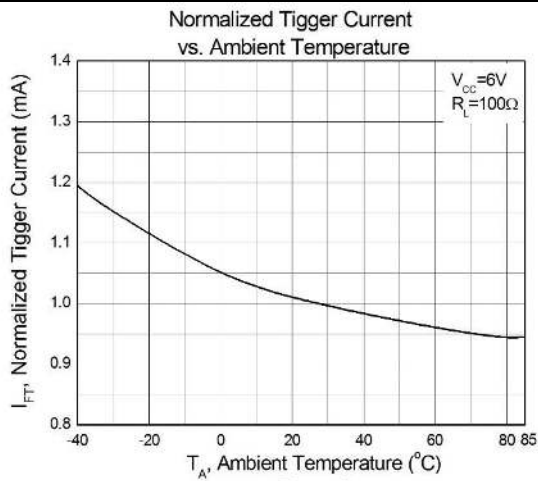


Figure 3

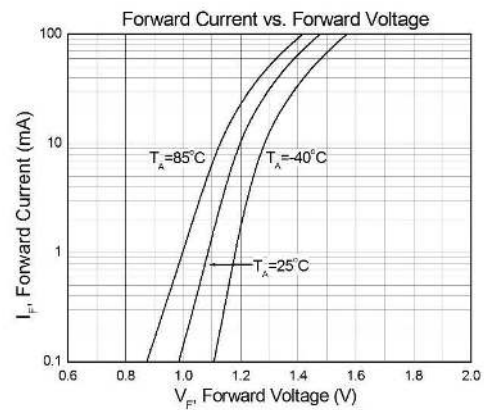


Figure 4

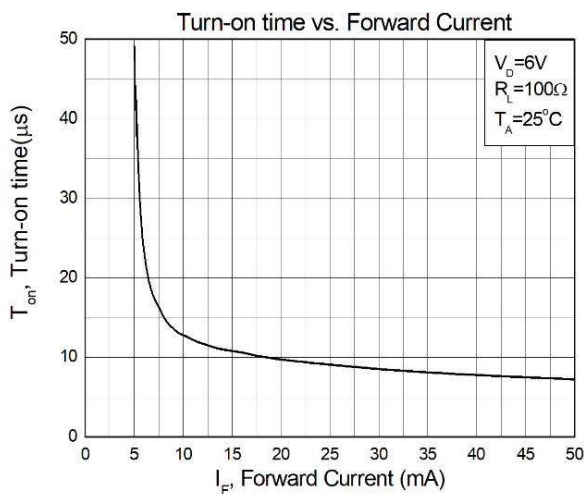


Figure 5

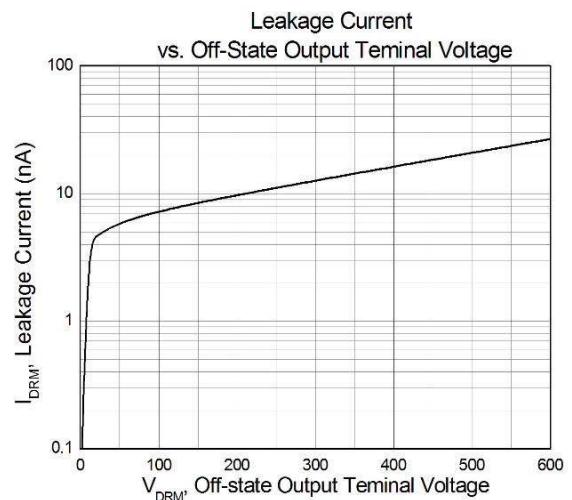
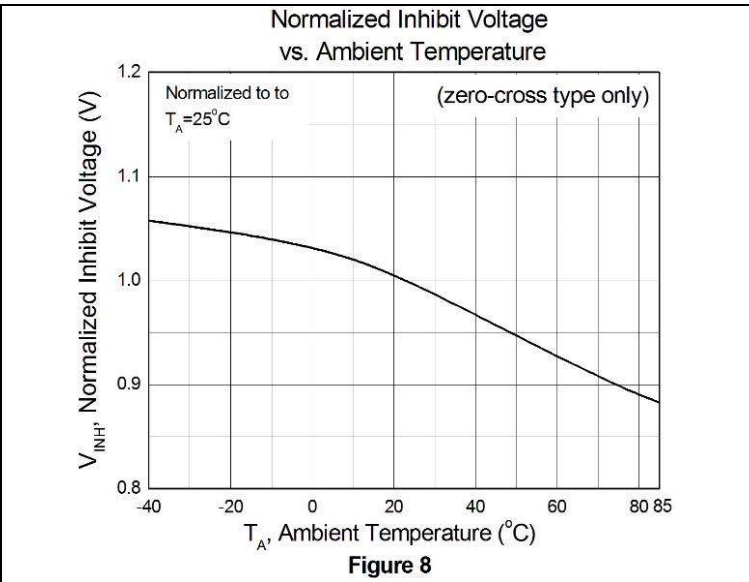
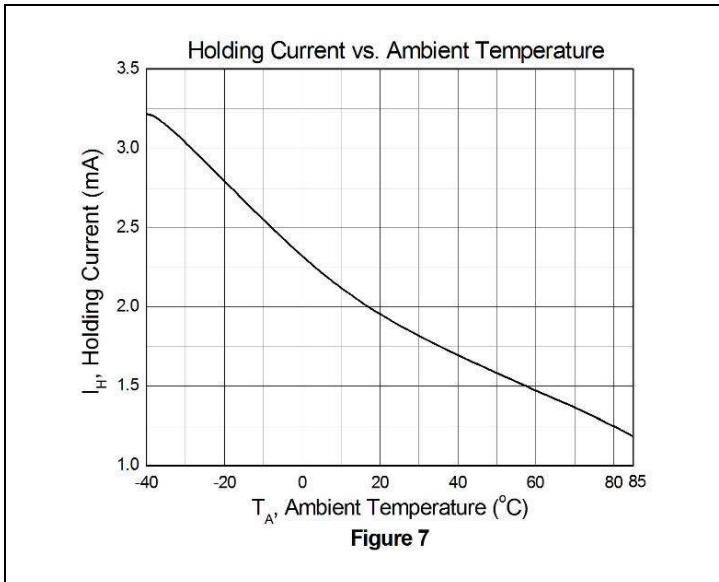
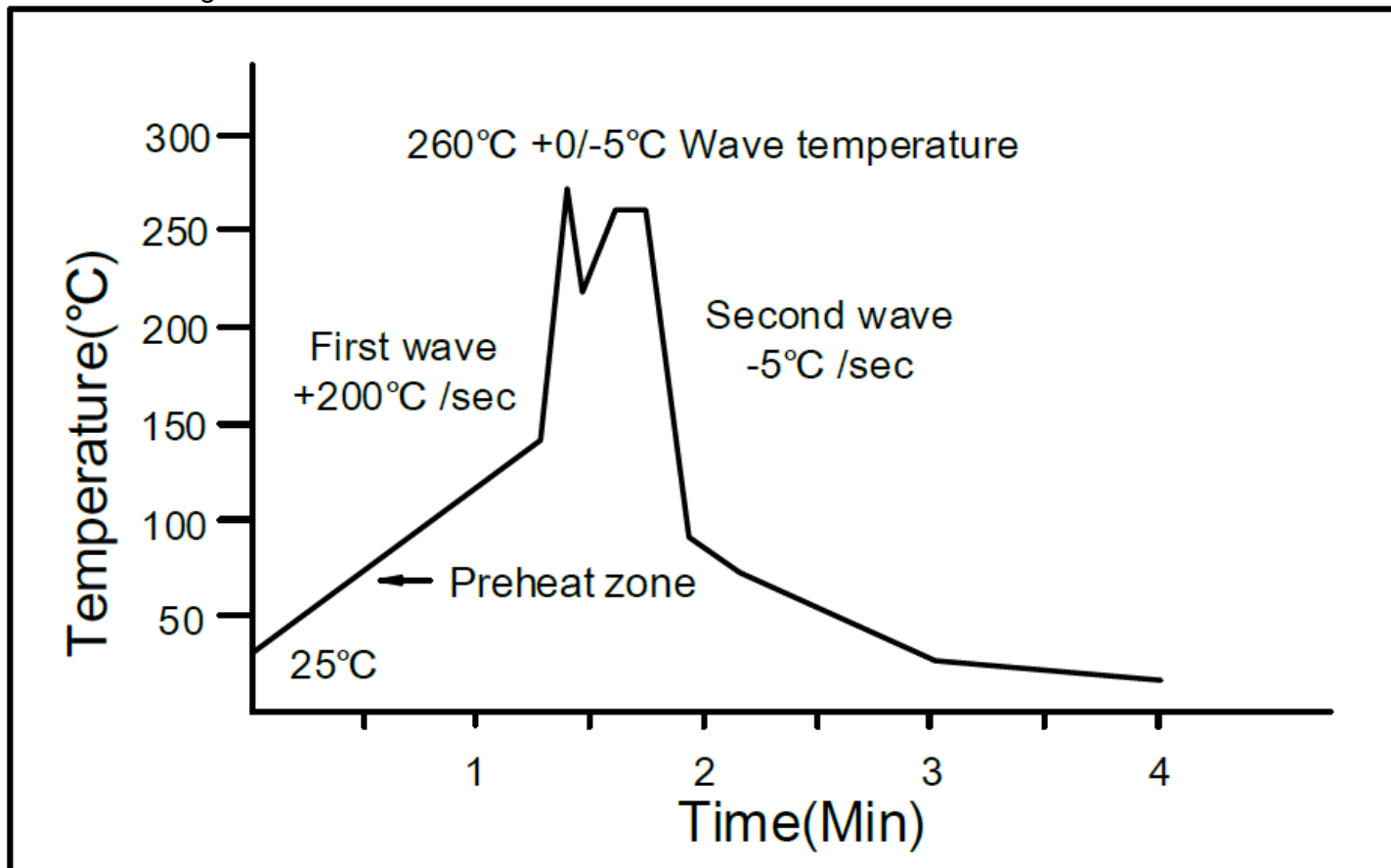


Figure 6



Solder Profile & Footprint

Wave soldering



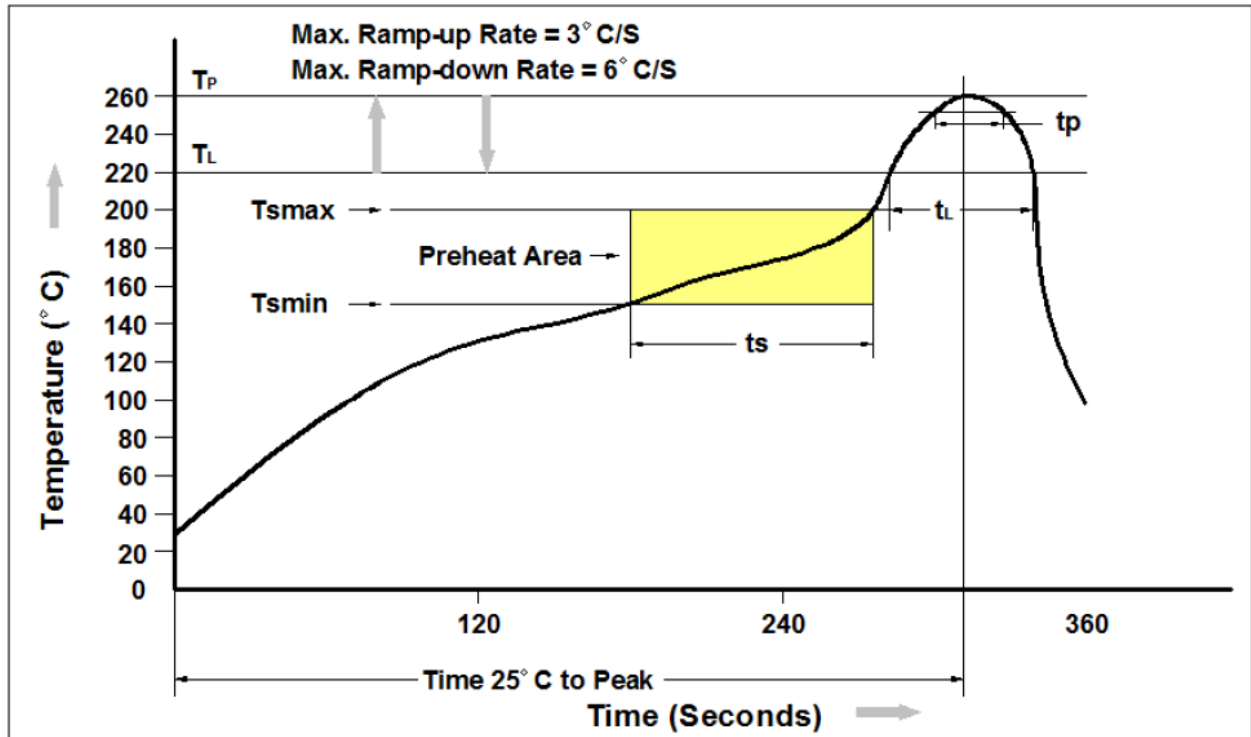
Temperature: 260 +0/-5 °C

Time: 10 Sec

Preheat temperature: 25 to 140 °C

Preheat time: 30 to 80 sec.

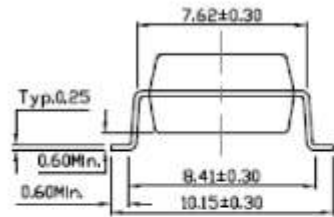
Reflow soldering



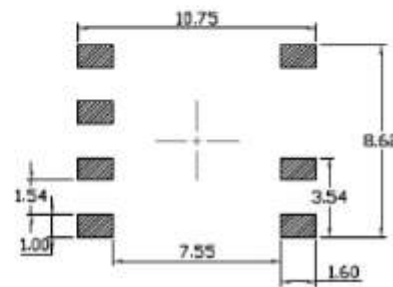
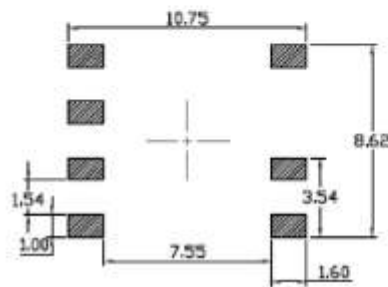
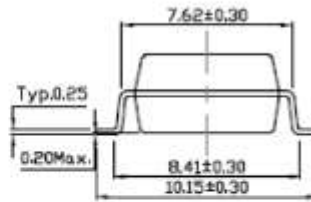
Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T _{smin})	150 °C
Temperature Max. (T _{smax})	200 °C
Time (t _s) from (T _{smin} to T _{smax})	60-120 seconds
Ramp-up Rate (t _L to t _p)	3°C/second max.
Liquidous Temperature (T _L)	217 °C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260 °C +0 °C / -5 °C
Time (t _p) within 5 °C of 260 °C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25 °C to Peak Temperature	8 minutes max.

Recommended Solder Footprint for SMD Leadform

S Type



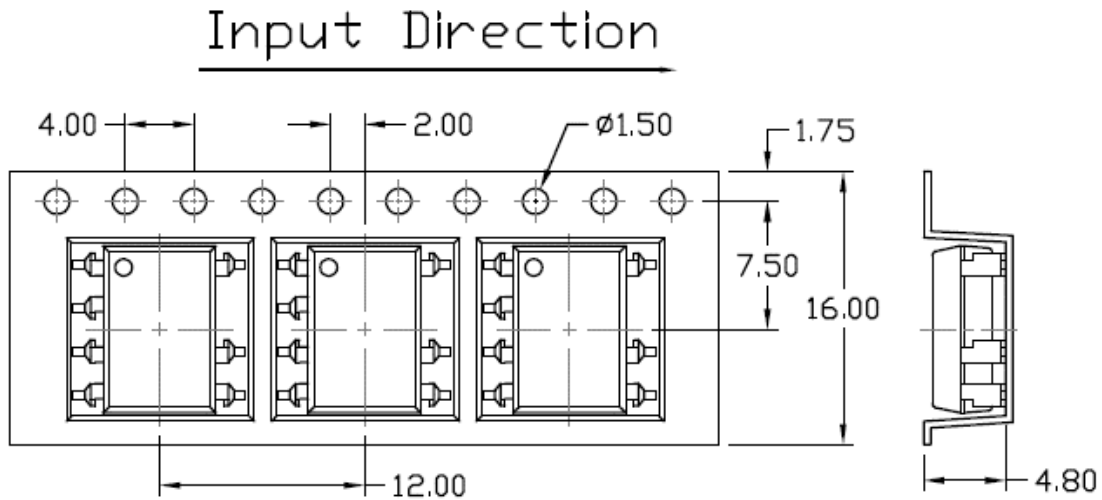
SL Type



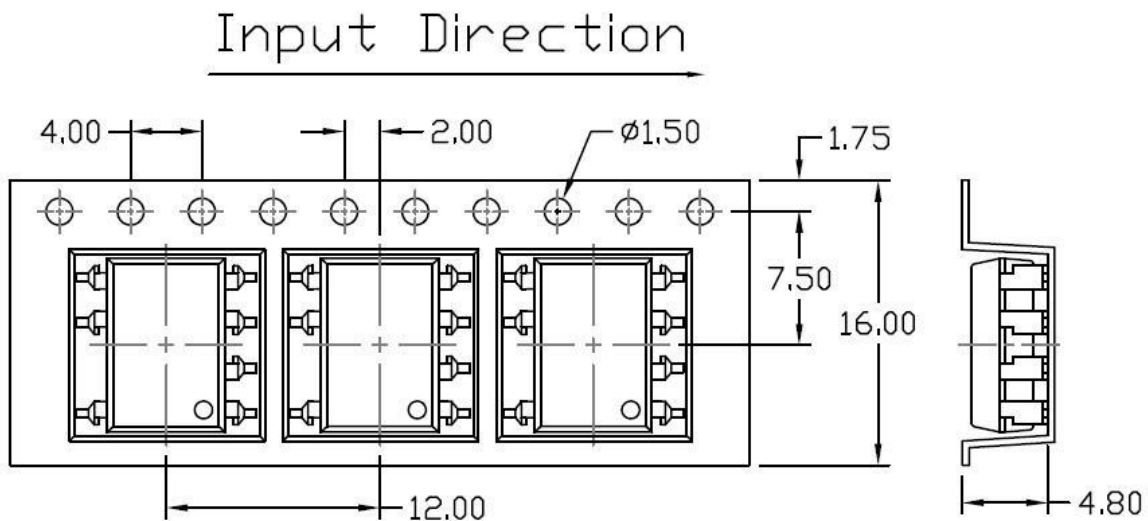
Units: mm

Packing & Labeling

Tape Dimension:
Option ST1 & SLT1

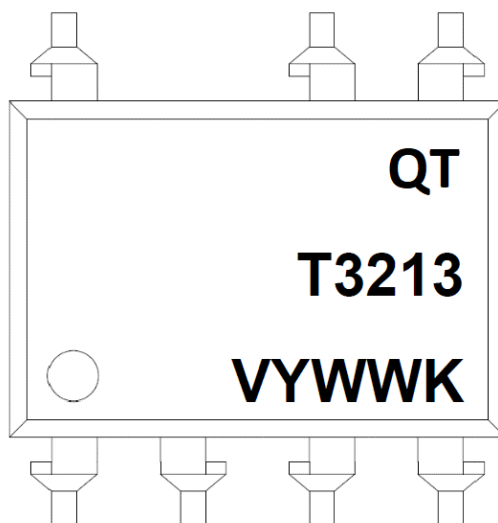


Option ST2 & SLT2



Unit: mm

Product: QTTX213 series	Date: March 27, 2023	Page 13 of 15
	Version# 1.1	

Device Marking:

QT = QT-Brightek Corporation

T3213 = part number

Y = Year

WW = Week

V = VDE Option

K= Manufacturing code

Ordering Information

QTTX213VY(Z)

TX213 = Part number (X=0, 1, 2, or 3)

V = VDE option (V or None)

Y = Lead form option (S, SL, M or none)

Z = Tape and reel option (T1 or T2 or none)

Option	Description	Quantity
None	Standard 8-Pin DIP	40 Units/Tube
M	Gullwing	40 Units/Tube
ST1	Surface Mount Lead Forming – with Option 1 Taping	1000 pcs/ reel
ST2	Surface Mount Lead Forming – with Option 2 Taping	1000 pcs/ reel
SLT1	SMD (Low Profile) Lead Forming – with Option 1 Taping	1000 pcs/ reel
SLT2	SMD (Low Profile) Lead Forming – with Option 2 Taping	1000 pcs/ reel



Revision History

Description:	Revision #	Revision Date
Initial of QTTX213 series	1.0	02/02/2018
Update schematic	1.1	03/27/2023

Disclaimer

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.